

CMOS, Low Voltage Serially Controlled, Octal SPST Switches

ADG714/ADG715

FEATURES

ADG714 SPI™/QSPI™/MICROWIRE™-Compatible Interface
ADG715 I²C™-Compatible Interface
2.7 V to 5.5 V Single Supply
±2.5 V Dual Supply
2.5 Ω On Resistance
0.6 Ω On Resistance Flatness
100 pA Leakage Currents
Octal SPST
Power-On Reset
Fast Switching Times
TTL/CMOS-Compatible

APPLICATIONS
Data Acquisition Systems
Communication Systems
Relay Replacement
Audio and Video Switching

Small TSSOP Package

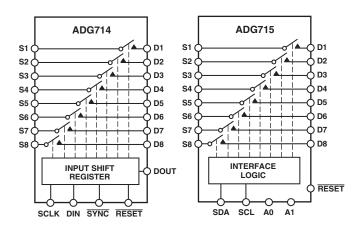
GENERAL DESCRIPTION

The ADG714/ADG715 are CMOS, octal SPST (single-pole, single-throw) switches controlled via either a 2- or 3-wire serial interface. On resistance is closely matched between switches and very flat over the full signal range. Each switch conducts equally well in both directions and the input signal range extends to the supplies. Data is written to these devices in the form of 8 bits, each bit corresponding to one channel.

The ADG714 uses a 3-wire serial interface that is compatible with SPI, QSPI, and MICROWIRE and most DSP interface standards. The output of the shift register DOUT enables a number of these parts to be daisy chained.

The ADG715 uses a 2-wire serial interface that is compatible with the I²C interface standard. The ADG715 has four hard wired addresses, selectable from two external address pins (A0 and A1). This allows the 2 LSBs of the 7-bit slave address to be set by the user. A maximum of four of these devices may be connected to the bus.

FUNCTIONAL BLOCK DIAGRAMS



On power-up of these devices, all switches are in the OFF condition, and the internal registers contain all zeros.

Low power consumption and operating supply range of 2.7 V to 5.5 V make this part ideal for many applications. These parts may also be supplied from a dual ± 2.5 V supply. The ADG714 and ADG715 are available in a small 24-lead TSSOP package.

PRODUCT HIGHLIGHTS

- 1. 2- or 3-wire serial interface
- 2. Single/dual supply operation. The ADG714 and ADG715 are fully specified and guaranteed with 3 V, 5 V, and ± 2.5 V supply rails.
- 3. Low on resistance, typically 2.5 Ω
- 4. Low leakage
- 5. Power-on reset
- 6. Small 24-lead TSSOP package

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REV.C

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$ADG714/ADG715 — SPECIFICATIONS^1 (v_{DD} = 5 \text{ V} \pm 10\%, v_{SS} = 0 \text{ V}, \text{ GND} = 0 \text{ V} \text{ unless otherwise noted.})$

| | B Versi | | | |
|--|------------------------|------------------------|------------------|--|
| Parameter | +25°C | -40°C to +85°C | Unit | Test Conditions/Comments |
| ANALOG SWITCH | | | - | |
| Analog Signal Range | | 0 V to V _{DD} | V | |
| On Resistance (R _{ON}) | 2.5 | O V to VDD | Ωtyp | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| on resistance (ROM) | 4.5 | 5 | Ω max | , , , , , , , , , , , , , , , , , , , |
| On Resistance Match Between Channels (ΔR_{ON}) | 1.5 | 0.4 | Ω typ | |
| | | 0.8 | Ω max | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| On Resistance Flatness (R _{FLAT(ON)}) | 0.6 | | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| (-TLAT(ON)) | | 1.2 | Ω max | .3 |
| LEAKAGE CURRENTS | | | | V -55V |
| Source OFF Leakage I _S (OFF) | ±0.01 | | n A trin | $V_{DD} = 5.5 \text{ V}$ $V_{D} = 4.5 \text{ V}/1 \text{ V}, V_{S} = 1 \text{ V}/4.5 \text{ V}$ |
| Source Off Leakage Is (Off) | ± 0.01 ± 0.1 | ±0.3 | nA typ nA max | $v_D - 4.3 \text{ V/I } \text{ V, } v_S - 1 \text{ V/4.3 V}$ |
| Drain OFF Leakage I _D (OFF) | ± 0.1 ± 0.01 | ±0.5 | nA typ | $V_D = 4.5 \text{ V/1 V}, V_S = 1 \text{ V/4.5 V}$ |
| Diani Orr Leakage ID (Orr) | ± 0.01 | ±0.3 | nA max | VD - 4.5 V/1 V, VS - 1 V/4.5 V |
| Channel ON Leakage I _D , I _S (ON) | ± 0.1 ± 0.01 | ±0.5 | nA typ | $V_D = V_S = 1 \text{ V, or } 4.5 \text{ V}$ |
| Chamler ON Leakage ID, IS (ON) | ± 0.01 ± 0.1 | ±0.3 | nA max | v _D = v _S = 1 v, 01 4.5 v |
| DIGITAL DIDITIO (OCI VI DOL OVI) | ±0.1 | ±0.5 | III I III ax | |
| DIGITAL INPUTS (SCLK, DIN, SYNC, A0, A1) | | 2.4 | | |
| Input High Voltage, V _{INH} | | 2.4 | V min | |
| Input Low Voltage, V _{INL} | 0.005 | 0.8 | V max | 37 - 37 37 |
| Input Current, I _{INL} or I _{INH} | 0.005 | 101 | μA typ | $V_{\rm IN} = V_{\rm INL}$ or $V_{\rm INH}$ |
| C D' : 11 C 2 | 2 | ± 0.1 | μA max | |
| C _{IN} , Digital Input Capacitance ² | 3 | | pF typ | |
| DIGITAL OUTPUT ADG714 DOUT ² | | | | |
| Output Low Voltage | | 0.4 | V max | $I_{SINK} = 6 \text{ mA}$ |
| C _{OUT} Digital Output Capacitance | 4 | | pF typ | |
| DIGITAL INPUTS (SCL, SDA) ² | | | | |
| Input High Voltage, V _{INH} | | $0.7 V_{DD}$ | V min | |
| r as 8 as a second livin | | $V_{\rm DD} + 0.3$ | V max | |
| Input Low Voltage, V _{INL} | | -0.3 | V min | |
| and the man is a second of the man is a secon | | $0.3~\mathrm{V_{DD}}$ | V max | |
| I _{IN} , Input Leakage Current | 0.005 | DD | μA typ | $V_{IN} = 0 \text{ V to } V_{DD}$ |
| no r | | ±1 | μA max | IN SECTION |
| V _{HYST} , Input Hysteresis | $0.05~\mathrm{V_{DD}}$ | | V min | |
| C _{IN} , Input Capacitance | 6 | | pF typ | |
| LOGIC OUTPUT (SDA) ² | | | 1 31 | |
| V_{OL} , Output Low Voltage | | 0.4 | V max | $I_{SINK} = 3 \text{ mA}$ |
| VOL, Output Low Voltage | | 0.6 | V max | $I_{SINK} = 5 \text{ mA}$ $I_{SINK} = 6 \text{ mA}$ |
| | | 0.0 | VIIIAX | ISINK - 0 IIII |
| DYNAMIC CHARACTERISTICS ² | | | | |
| t _{ON} ADG714 | 20 | 20 | ns typ | $V_S = 3 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| ADOR15 | 0.5 | 32 | ns max | W 4M P 400 C C 27 F |
| t _{ON} ADG715 | 95 | 1.40 | ns typ | $V_S = 3 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| 4 ADC714 | 0 | 140 | ns max | V - 2 V D - 200 C C - 25 E |
| t _{OFF} ADG714 | 8 | 1.5 | ns typ | $V_S = 3 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| 4 ADC715 | 0.5 | 15 | ns max | V - 2 V D - 200 O C 25 E |
| t _{OFF} ADG715 | 85 | 120 | ns typ | $V_S = 3 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| Decal Defens Mala Til Dil | 0 | 130 | ns max | V - 2 V D - 200 C C - 25 E |
| Break-Before-Make Time Delay, t _D | 8 | 1 | ns typ | $V_S = 3 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| Charge Injection | ⊥2 | 1 | ns min | V = 2 V P = 0 O C = 1 = E |
| Charge Injection | ±3 | | pC typ | $V_S = 2 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$ |
| Off Isolation | -60 80 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ |
| Channel to Charrel Correct-11 | -80 70 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$ |
| Channel-to-Channel Crosstalk | -70 00 | | dB typ | $R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 10 \text{ MHz}$ |
| 2 JD D J: Jal | -90 | | dB typ | $R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz$ |
| -3 dB Bandwidth | 155 | | MHz typ | $R_L = 50 \Omega$, $C_L = 5 pF$ |
| C_{S} (OFF) | 11 | | pF typ | |
| $C_{\rm D}$ (OFF) | 11 | | pF typ | |
| $C_D, C_S(ON)$ | 22 | | pF typ | |
| POWER REQUIREMENTS | | | | $V_{\rm DD} = 5.5 \text{ V}$ |
| $I_{ m DD}$ | 10 | | μA typ | Digital Inputs = 0 V or 5.5 V |
| | | 20 | μA max | |

NOTES

 $^{^{1}}Temperature$ range is as follows: B Version: –40°C to +85°C.

²Guaranteed by design, not subject to production test.

$\label{eq:continuous} \textbf{SPECIFICATIONS}^1 \, (v_{DD} = 3 \, v \, \pm 10\%, \, v_{SS} = 0 \, v, \, \text{GND} = 0 \, v \, \, \text{unless otherwise noted.})$

| | B Versi | on –40°C | | |
|--|------------------------|------------------------|-------------------|--|
| Parameter | +25°C | -40°C to +85°C | Unit | Test Conditions/Comments |
| ANALOG SWITCH | | | | |
| Analog Signal Range | | 0 V to V _{DD} | V | |
| On Resistance (R _{ON}) | 6 | o v to vDD | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| 2 2 CON/ | 11 | 12 | Ω max | · 3 · · · · · · · · · · · · · · · · · · |
| On Resistance Match Between Channels (ΔR_{ON}) | | 0.4 | Ωtyp | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| , O10 | | 1.2 | Ω max | 5 22, 6 |
| On Resistance Flatness (R _{FLAT(ON)}) | | 3.5 | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_S = 10 \text{ mA}$ |
| LEAKAGE CURRENTS | | | | $V_{\rm DD} = 3.3 \text{ V}$ |
| Source OFF Leakage I _S (OFF) | ±0.01 | | nA typ | $V_S = 3 \text{ V/1 V}, V_D = 1 \text{ V/3 V}$ |
| • • • • | ±0.1 | ± 0.3 | nA max | |
| Drain OFF Leakage I _D (OFF) | ±0.01 | | nA typ | $V_S = 1 \text{ V/3 V}, V_D = 3 \text{ V/1 V}$ |
| | ±0.1 | ± 0.3 | nA max | |
| Channel ON Leakage I_D , I_S (ON) | ± 0.01 | | nA typ | $V_S = V_D = 1 V$, or 3 V |
| | ±0.1 | ±0.3 | nA max | |
| DIGITAL INPUTS (SCLK, DIN, SYNC, A0, A1) | | | | |
| Input High Voltage, V _{INH} | | 2.0 | V min | |
| Input Low Voltage, V _{INL} | | 0.8 | V max | l |
| Input Current, I _{INL} or I _{INH} | 0.005 | | μA typ | $V_{IN} = V_{INL}$ or V_{INH} |
| | | ± 0.1 | μA max | |
| C _{IN} , Digital Input Capacitance ² | 3 | | pF typ | |
| DIGITAL OUTPUT ADG714 DOUT ² | | | | |
| Output Low Voltage | | 0.4 | V max | $I_{SINK} = 6 \text{ mA}$ |
| C _{OUT} Digital Output Capacitance | 4 | | pF typ | |
| DIGITAL INPUTS (SCL, SDA) ² | | | | |
| Input High Voltage, V _{INH} | | $0.7~\mathrm{V_{DD}}$ | V min | |
| | | $V_{\rm DD} + 0.3$ | V max | |
| Input Low Voltage, V _{INL} | | -0.3 | V min | |
| | 0.005 | $0.3~\mathrm{V_{DD}}$ | V max | ¥7 0 ¥7 × ¥7 |
| I _{IN} , Input Leakage Current | 0.005 | ±1 | μA typ | $V_{IN} = 0 \text{ V to } V_{DD}$ |
| V _{HYST} , Input Hysteresis | 0.05 V _{DD} | Ξ1 | μA max V min | |
| C_{IN} , Input Capacitance | 6 0.03 V _{DD} | | pF typ | |
| LOGIC OUTPUT (SDA) ² | | | pr typ | |
| V _{OL} , Output Low Voltage | | 0.4 | V max | I = 2 m A |
| VOL, Output Low Voltage | | 0.4 | V max | $I_{SINK} = 3 \text{ mA}$ $I_{SINK} = 6 \text{ mA}$ |
| DIALANIC CHARACTERIOTICS? | | 0.0 | VIIIax | ISINK - 0 IIII |
| DYNAMIC CHARACTERISTICS ² | 25 | | | V - 2 V D - 200 O C - 25 - E |
| $t_{\rm ON}$ ADG714 | 35 | 65 | ns typ | $V_S = 2 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| t _{ON} ADG715 | 130 | 05 | ns max | $V_S = 2 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| ton ADG/13 | 150 | 200 | ns typ ns max | vs = 2 v, n _L = 300 22, G _L = 33 pr |
| t _{OFF} ADG714 | 11 | 200 | ns typ | $V_S = 2 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| -OFF= | | 20 | ns max | ·3 - ·)L · · · · · · · · · · · · · · · · · · |
| t _{OFF} ADG715 | 115 | | ns typ | $V_S = 2 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| | | 180 | ns max | |
| Break-Before-Make Time Delay, t _D | 8 | | ns typ | $V_S = 2 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| | | 1 | ns min | |
| Charge Injection | ±2 | | pC typ | $V_S = 1.5 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$ |
| Off Isolation | -60 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ |
| | - 80 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$ |
| Channel-to-Channel Crosstalk | -70 -90 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ |
| -3 dB Bandwidth | 155 | | dB typ | $R_{L} = 50 \Omega$, $C_{L} = 5 pF$, $f = 1 MHz$ $R_{L} = 50 \Omega$, $C_{L} = 5 pF$ |
| C _S (OFF) | 111 | | MHz typ pF typ | 1√ – 20 27, CT – 2 ht. |
| C_{S} (OFF) | 11 | | pF typ | |
| C_D , C_S (ON) | 22 | | pF typ | |
| POWER REQUIREMENTS | | | r Jr | $V_{\rm DD}$ = 3.3 V |
| I _{DD} | 10 | | μA typ | $V_{DD} = 3.3 \text{ V}$ Digital Inputs = 0 V or 3.3 V |
| ≛עע | 10 | 20 | μΑ typ μΑ max | Digital hipato – 0 v of 3.3 v |
| | | 20 | MIIIIAA | |

NOTES ¹Temperature range is as follows: B Version: -40°C to +85°C. ²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG714/ADG715—SPECIFICATIONS1

 $\label{eq:DUAL SUPPLY} \textbf{DUAL SUPPLY} \ (V_{DD} = +2.5 \ V \pm 10\%, V_{SS} = -2.5 \ V \pm 10\%, GND = 0 \ V \ unless \ otherwise \ noted.)$

| | B Versi | | | |
|--|----------------------|-----------------------|------------------|--|
| Parameter | +25°C | -40°C to +85°C | Unit | Test Conditions/Comments |
| ANALOG SWITCH | 123 C | 10 183 C | Cint | 1 est conditions/comments |
| Analog Signal Range | | V_{SS} to V_{DD} | V | |
| On Resistance (R _{ON}) | 2.5 | VSS to VDD | Ω typ | $V_S = V_{SS}$ to V_{DD} , $I_{DS} = 10$ mA |
| on resistance (10N) | 4.5 | 5 | Ω max | , 2 , 22 to 1 DD, 1 DS 10 1 m1 |
| On Resistance Match Between Channels (ΔR_{ON}) | | 0.4 | Ωtyp | $V_S = V_{SS}$ to V_{DD} , $I_{DS} = 10$ mA |
| | | 0.8 | Ω max | - 13 13 11 1 DD D3 |
| On Resistance Flatness (R _{FLAT(ON)}) | 0.6 | | Ω typ | $V_S = V_{SS}$ to V_{DD} , $I_{DS} = 10$ mA |
| (,- | | 1 | Ω max | |
| LEAKAGE CURRENTS | | | | $V_{DD} = +2.75 \text{ V}, V_{SS} = -2.75 \text{ V}$ |
| Source OFF Leakage I _S (OFF) | ±0.01 | | nA typ | $V_S = +2.25 \text{ V/}-1.25 \text{ V}, V_D = -1.25 \text{ V/}+2.25 \text{ V}$ |
| | ±0.1 | ± 0.3 | nA max | |
| Drain OFF Leakage I _D (OFF) | ± 0.01 | | nA typ | $V_S = +2.25 \text{ V/}-1.25 \text{ V}, V_D = -1.25 \text{ V/}+2.25 \text{ V}$ |
| | ± 0.1 | ± 0.3 | nA max | |
| Channel ON Leakage I_D , I_S (ON) | ± 0.01 | | nA typ | $V_S = V_D = +2.25 \text{ V}/-1.25 \text{ V}$ |
| | ±0.1 | ±0.3 | nA max | |
| DIGITAL INPUTS | | | | |
| Input High Voltage, V _{INH} | | 1.7 | V min | |
| Input Low Voltage, V _{INL} | | 0.7 | V max | |
| Input Current, I _{INL} or I _{INH} | 0.005 | 101 | μA typ | $V_{\rm IN} = V_{\rm INL}$ or $V_{\rm INH}$ |
| C. Digital Innut Committee 2 | | ± 0.1 | μA max | |
| C _{IN} , Digital Input Capacitance ² | 3 | | pF typ | |
| DIGITAL OUTPUT ADG714 DOUT ² | | | | |
| Output Low Voltage | | 0.4 | V max | $I_{SINK} = 6 \text{ mA}$ |
| C _{OUT} Digital Output Capacitance | 4 | | pF typ | |
| DIGITAL INPUTS (SCL, SDA) ² | | | | |
| Input High Voltage, V _{INH} | | $0.7~\mathrm{V_{DD}}$ | V min | |
| | | $V_{\rm DD} + 0.3$ | V max | |
| Input Low Voltage, V _{INL} | | -0.3 | V min | |
| | | $0.3~\mathrm{V_{DD}}$ | V max | |
| I _{IN} , Input Leakage Current | 0.005 | | μA typ | $V_{IN} = 0 \text{ V to } V_{DD}$ |
| TI I III ' | 0.05 17 | ±1 | μA max | |
| V _{HYST} , Input Hysteresis | 0.05 V _{DD} | | V min | |
| C _{IN} , Input Capacitance | 0 | | pF typ | |
| LOGIC OUTPUT (SDA) ² | | | | |
| V _{OL} , Output Low Voltage | | 0.4 | V max | $I_{SINK} = 3 \text{ mA}$ |
| | | 0.6 | V max | I _{SINK} = 6 mA |
| DYNAMIC CHARACTERISTICS ² | | | | |
| t _{ON} ADG714 | 20 | | ns typ | $V_S = 1.5 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| ADORIS | 122 | 32 | ns max | W 15W D 200 O 25 F |
| t _{ON} ADG715 | 133 | 200 | ns typ | $V_S = 1.5 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| + ADG714 | 8 | 200 | ns max | V - 15 V P - 200 O C - 25 - E |
| t _{OFF} ADG714 | 0 | 18 | ns typ ns max | $V_S = 1.5 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| t _{OFF} ADG715 | 124 | 10 | ns typ | $V_S = 1.5 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| UPF TIDO (I) | 127 | 190 | ns typ | 12 - 1.2 1, 17 - 200 25, OF - 22 ht. |
| Break-Before-Make Time Delay, t _D | 8 | 100 | ns typ | $V_S = 1.5 \text{ V}, R_L = 300 \Omega, C_L = 35 \text{ pF}$ |
| | | 1 | ns min | , 500 mm, CL 55 pr |
| Charge Injection | ±3 | | pC typ | $V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$ |
| Off Isolation | -60 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ |
| | -80 | | dB typ | $R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz$ |
| Channel-to-Channel Crosstalk | -70 | | dB typ | $R_{L} = 50 \Omega$, $C_{L} = 5 pF$, $f = 10 MHz$ |
| | -90 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$ |
| -3 dB Bandwidth | 155 | | MHz typ | $R_L = 50 \Omega$, $C_L = 5 pF$ |
| C_{S} (OFF) | 11 | | pF typ | |
| C_{D} (OFF) | 11 | | pF typ | |
| $C_D, C_S(ON)$ | 22 | | pF typ | |
| POWER REQUIREMENTS | | | | $V_{DD} = +2.75 \text{ V}, V_{SS} = -2.75 \text{ V}$ |
| I_{DD} | 15 | | μA typ | Digital Inputs = 0 V or V_{DD} |
| | | 25 | μA max | |
| I_{SS} | 15 | | μA typ | |
| | | 25 | μA max | i |

NOTES ¹Temperature range is as follows: B Version: –40°C to +85°C.

²Guaranteed by design, not subject to production test.

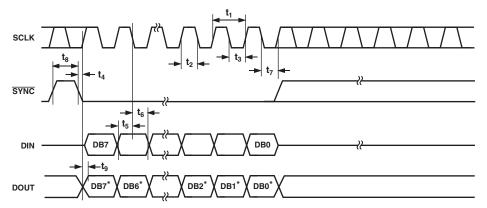
Specifications subject to change without notice.

ADG714 TIMING CHARACTERISTICS 1, 2 ($V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$. All specifications -40°C to $+85^{\circ}\text{C}$ unless otherwise noted.)

| Parameter | Limit at T _{MIN} , T _{MAX} | Unit | Conditions/Comments |
|--------------------|--|---------|---------------------------------------|
| f_{SCLK} | 30 | MHz max | SCLK Cycle Frequency |
| t_1 | 33 | ns min | SCLK Cycle Time |
| t_2 | 13 | ns min | SCLK High Time |
| t_3 | 13 | ns min | SCLK Low Time |
| t_4 | 0 | ns min | SYNC to SCLK Rising Edge Setup Time |
| t ₅ | 5 | ns min | Data Setup Time |
| t ₆ | 4.5 | ns min | Data Hold Time |
| t_7 | 0 | ns min | SCLK Falling Edge to SYNC Rising Edge |
| t ₈ | 33 | ns min | Minimum SYNC High Time |
| t_9 ³ | 20 | ns max | SCLK Rising Edge to DOUT Valid |

NOTES

Specifications subject to change without notice.



*DATA FROM PREVIOUS WRITE CYCLE

Figure 1. 3-Wire Serial Interface Timing Diagram

REV. C _5_

¹See Figure 1.

 $^{^2}$ All input signals are specified with tr = tf = 5 ns (10% to 90% of V_{DD}) and timed from a voltage level of ($V_{IL} + V_{IH}$)/2.

 $^{{}^{3}}C_{L} = 20 \text{ pF}, R_{L} = 1 \text{ k}\Omega.$

$\textbf{ADG715 TIMING CHARACTERISTICS}^1 \text{ (V}_{DD} = 2.7 \text{ V to } 5.5 \text{ V. All specifications} -40^{\circ}\text{C to } +85^{\circ}\text{C unless otherwise noted.)}$

| Parameter | Limit at T _{MIN} , T _{MAX} | Unit | Conditions/Comments |
|-----------------|--|---------|---|
| f_{SCL} | 400 | kHz max | SCL Clock Frequency |
| t_1 | 2.5 | μs min | SCL Cycle Time |
| t_2 | 0.6 | μs min | t _{HIGH} , SCL High Time |
| t ₃ | 1.3 | μs min | t _{LOW} , SCL Low Time |
| t_4 | 0.6 | μs min | t _{HD, STA} , Start/Repeated Start Condition Hold Time |
| t ₅ | 100 | ns min | t _{SU, DAT} , Data Setup Time |
| t_5 t_6^2 | 0.9 | μs max | t _{HD, DAT} , Data Hold Time |
| | 0 | μs min | |
| t ₇ | 0.6 | μs min | t _{SU, STA} , Setup Time for Repeated Start |
| t ₈ | 0.6 | μs min | t _{SU, STO} , Stop Condition Setup Time |
| t ₉ | 1.3 | μs min | t _{BUF} , Bus Free Time Between a STOP Condition and |
| | | | a Start Condition |
| t ₁₀ | 300 | ns max | t _R , Rise Time of Both SCL and SDA When Receiving |
| | $20 + 0.1C_b^3$ | ns min | |
| t ₁₁ | 250 | ns max | t _F , Fall Time of SDA When Receiving |
| t ₁₁ | 300 | ns max | t _F , Fall Time of SDA When Transmitting |
| | $0.1C_{b}^{3}$ | ns min | |
| C _b | 400 | pF max | Capacitive Load for Each Bus Line |
| t_{SP}^4 | 50 | ns max | Pulsewidth of Spike Suppressed |

NOTES

Specifications subject to change without notice.

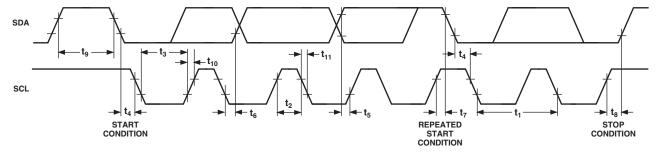


Figure 2. 2-Wire Serial Interface Timing Diagram

-6-

REV. C

¹See Figure 2.

²A master device must provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IH} min of the SCL signal) in order to bridge the undefined region of SCL's falling edge.

 $^{^3}C_b$ is the total capacitance of one bus line in pF. t_R and t_F measured between 0.3 V_{DD} and 0.7 V_{DD} . 4 Input filtering on both the SCL and SDA inputs suppress noise spikes that are less than 50 ns.

ABSOLUTE MAXIMUM RATINGS¹

TSSOP Package

| θ_{JA} Thermal Impedance | 128°C/W |
|--------------------------------------|---------|
| θ_{IC} Thermal Impedance | 42°C/W |
| Lead Temperature, Soldering (10 sec) | . 300°C |
| Infrared Reflow (20 sec) | . 235°C |

NOTES

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

²Overvoltages at IN, S, or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

CAUTION_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG714/ADG715 feature proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATIONS 24-Lead TSSOP

| | Г | \neg | ٦. | |
|----------|----|---------------|----|----------|
| SCLK | 1 | • | 24 | SYNC |
| V_{DD} | 2 | | 23 | RESET |
| DIN | 3 | | 22 | DOUT |
| GND | 4 | | 21 | V_{SS} |
| S1 | 5 | ADG714 | 20 | S8 |
| D1 | 6 | TOP VIEW | 19 | D8 |
| S2 | 7 | (Not to Scale | 18 | S7 |
| D2 | 8 | | 17 | D7 |
| S3 | 9 | | 16 | S6 |
| D3 | 10 | | 15 | D6 |
| S4 | 11 | | 14 | S5 |
| D4 | 12 | | 13 | D5 |
| | L | | | |

| SCL 1 V _{DD} 2 SDA 3 GND 4 S1 5 | • ADG715 | 24 23 22 21 | A0 RESET A1 V _{SS} S8 |
|---|----------------------------|----------------------------------|--|
| D1 6 S2 7 D2 8 S3 9 D3 10 S4 11 D4 12 | TOP VIEW (Not to Scale) | 19 18 17 16 15 14 | D8 S7 D7 S6 D6 S5 D5 |

REV. C -7-

ADG714 PIN FUNCTION DESCRIPTIONS

| Pin No. | Mnemonic | Description |
|--------------------------------|-------------------|--|
| 1 | SCLK | Serial Clock Input. Data is clocked into the input shift register on the falling edge of the serial clock input. These devices can accommodate serial input rates of up to 30 MHz. |
| 2 | V_{DD} | Positive Analog Supply Voltage. |
| 3 | DIN | Serial Data Input. Data is clocked into the 8-bit input register on the falling edge of the serial clock input. |
| 4 | GND | Ground Reference |
| 5, 7, 9, 11, 14, 16, 18, 20 | Sx | Source. May be an input or output. |
| 6, 8, 10, 12, 13, 15, 17, 19 | Dx | Drain. May be an input or output. |
| 21 | V_{SS} | Negative Analog Supply Voltage. For single supply operation this should be tied to GND. |
| 22 | DOUT | Serial Data Output. This allows a number a parts to be daisy chained. Data is clocked out of the input shift register on the rising edge of SCLK. DOUT is an open-drain output that should be pulled to the supply with an external pull-up resistor. |
| 23 | RESET | Active Low Control Input. Clears the input register and turns all switches to the OFF condition. |
| 24 | SYNC | Active Low Control Input. This is the frame synchronization signal for the input data. When \overline{SYNC} goes low, it powers on the SCLK and DIN buffers and the input shift register is enabled. Data is transferred on the falling edges of the following clocks. Taking \overline{SYNC} high updates the switches. |

ADG715 PIN FUNCTION DESCRIPTIONS

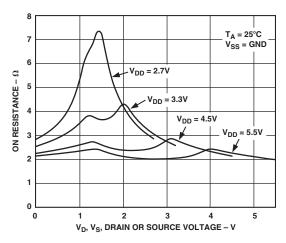
| Pin No. | Mnemonic | Description |
|--------------------------------|-------------|--|
| 1 | SCL | Serial Clock Line. This is used in conjunction with the SDA line to clock data into the 8-bit input shift register. Clock rates of up to 400 kbit/s can be accommodated with this 2-wire serial interface. |
| 2 | $ m V_{DD}$ | Positive Analog Supply Voltage |
| 3 | SDA | Serial Data Line. This is used in conjunction with the SCL line to clock data into the 8-bit input shift register during the write cycle and used to readback one byte of data during the read cycle. It is a bidirectional open-drain data line which should be pulled to the supply with an external pull-up resistor. |
| 4 | GND | Ground Reference |
| 5, 7, 9, 11, 14, 16, 18, 20 | Sx | Source. May be an input or output. |
| 6, 8, 10, 12, 13, 15, 17, 19 | Dx | Drain. May be an input or output. |
| 21 | V_{SS} | Negative Analog Supply Voltage. For single supply operation this should be tied to GND. |
| 22 | A1 | Address Input. Sets the second least significant bit of the 7-bit slave address. |
| 23 | RESET | Active Low Control Input. Clears the input register and turns all switches to the OFF condition. |
| 24 | A0 | Address Input. Sets the least significant bit of the 7-bit slave address. |

TERMINOLOGY

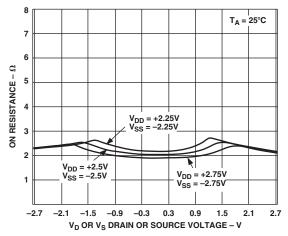
| $\overline{V_{\mathrm{DD}}}$ | Most positive power supply potential. | $\overline{C_D, C_S(ON)}$ | "ON" Switch Capacitance. Measured with ref- |
|------------------------------|--|---------------------------|--|
| V_{SS} | Most negative power supply in a dual supply | C | erence to ground. |
| | application. In single supply applications, this should be tied to ground. | C_{IN} | Digital Input Capacitance |
| I_{DD} | Positive Supply Current | t_{ON} | Delay time between loading new data to the shift register and selected switches switching on. |
| I_{SS} | Negative Supply Current | $t_{ m OFF}$ | Delay time between loading new data to the |
| GND | Ground (0 V) Reference | | shift register and selected switches switching off. |
| S | Source Terminal. May be an input or output. | Off Isolation | A measure of unwanted signal coupling through |
| D | Drain Terminal. May be an input or output. | | an "OFF" switch. |
| R_{ON} | Ohmic resistance between D and S | Crosstalk | A measure of unwanted signal which is coupled |
| ΔR_{ON} | On resistance match between any two channels, | | through from one channel to another as a result of parasitic capacitance. |
| | i.e., R _{ON} max–R _{ON} min. | Charge | A measure of the glitch impulse transferred |
| $R_{FLAT(ON)} \\$ | Flatness is defined as the difference between the maximum and minimum value of on resistance | Injection | from the digital input to the analog output during switching. |
| | as measured over the specified analog signal range. | Bandwidth | The frequency at which the output is attenuated |
| I _S (OFF) | Source leakage current with the switch "OFF." | Danawidii | by -3 dBs. |
| I _D (OFF) | Drain leakage current with the switch "OFF." | On Response | The frequency response of the "ON" switch. |
| I_D , I_S (ON) | Channel leakage current with the switch "ON." | Insertion Loss | |
| $V_{D}\left(V_{S}\right)$ | Analog voltage on terminals D and S | | Insertion Loss = 20 log ₁₀ (V _{OUT} with switch/ V _{OUT} without switch. |
| C_{S} (OFF) | "OFF" Switch Source Capacitance. Measured | V_{INL} | Maximum input voltage for Logic 0. |
| | with reference to ground. | V _{INH} | Minimum input voltage for Logic 1. |
| C_D (OFF) | "OFF" Switch Drain Capacitance. Measured | $I_{INL}(I_{INH})$ | Input current of the digital input. |
| | with reference to ground. | I _{DD} | Positive Supply Current |

REV. C _9_

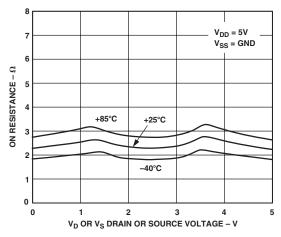
ADG714/ADG715—Typical Performance Characteristics



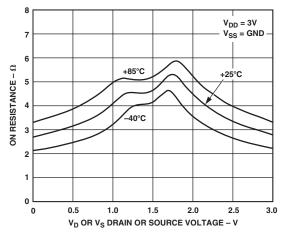
TPC 1. On Resistance as a Function of V_D (V_S) Single Supply



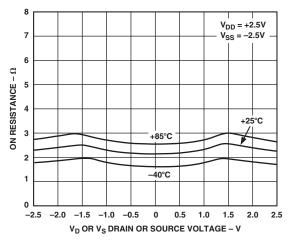
TPC 2. On Resistance as a Function of V_D (V_S); Dual Supply



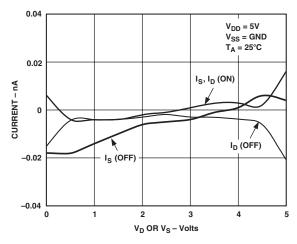
TPC 3. On Resistance as a Function of V_D (V_S) for Different Temperatures; $V_{DD} = 5 \text{ V}$



TPC 4. On Resistance as a Function of V_D (V_S) for Different Temperatures; $V_{DD} = 3 \ V$

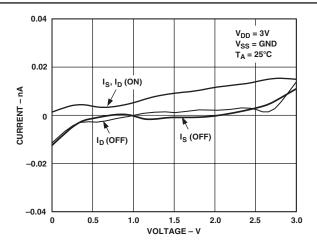


TPC 5. On Resistance as a Function of V_D (V_S) for Different Temperatures; Dual Supply

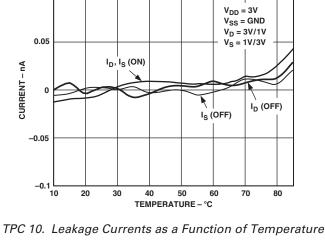


TPC 6. Leakage Currents as a Function of V_D (V_S)

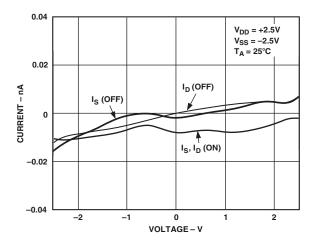
-10- REV. C



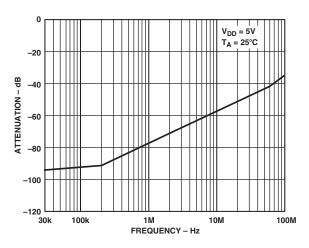
TPC 7. Leakage Currents as a Function of V_D (V_S)



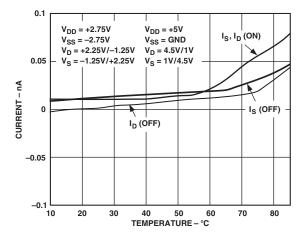
0.1



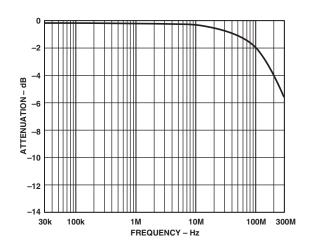
TPC 8. Leakage Currents as a Function of V_D (V_S) Dual Supply



TPC 11. Off Isolation vs. Frequency

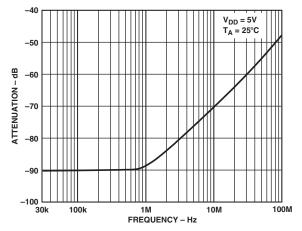


TPC 9. Leakage Currents as Function of Temperature

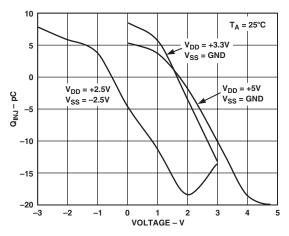


TPC 12. On Response vs. Frequency

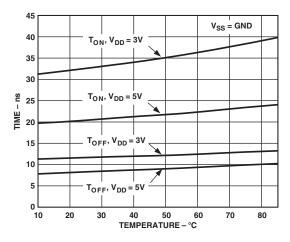
REV. C -11-



TPC 13. Crosstalk vs. Frequency



TPC 14. Charge Injection vs. Source/Drain Voltage



TPC 15. T_{ON}/T_{OFF} Times vs. Temperature for ADG714

GENERAL DESCRIPTION

The ADG714 and ADG715 are serially controlled, octal SPST switches, controlled by either a 2- or 3-wire interface. Each bit of the 8-bit serial word corresponds to one switch of the part. A Logic 1 in the particular bit position turns on the switch, while a Logic 0 turns the switch off. Because each switch is independently controlled by an individual bit, this provides the option of having any, all, or none of the switches ON.

When changing the switch conditions, a new 8-bit word is written to the input shift register. Some of the bits may be the same as the previous write cycle, as the user may not wish to change the state of some switches. To minimize glitches on the output of these switches, the part cleverly compares the state of switches from the previous write cycle. If the switch is already in the ON condition, and is required to stay ON, there will be minimal glitches on the output of the switch.

POWER-ON RESET

On power-up of the device, all switches will be in the OFF condition and the internal shift register is filled with zeros and will remain so until a valid write takes place.

SERIAL INTERFACE

3-Wire Serial Interface

The ADG714 has a 3-wire serial interface (SYNC, SCLK, and DIN), that is compatible with SPI, QSPI, MICROWIRE interface standards and most DSPs. Figure 1 shows the timing diagram of a typical write sequence.

Data is written to the 8-bit shift register via DIN under the control of the \overline{SYNC} and SCLK signals. Data may be written to the shift register in more or less than eight bits. In each case the shift register retains the last eight bits that were written.

When \$\overline{SYNC}\$ goes low, the input shift register is enabled. Data from DIN is clocked into the shift register on the falling edge of SCLK. Each bit of the 8-bit word corresponds to one of the eight switches. Figure 3 shows the contents of the input shift register. Data appears on the DOUT pin on the rising edge of SCLK suitable for daisy chaining, delayed of course by eight bits. When all eight bits have been written into the shift register, the \$\overline{SYNC}\$ line is brought high again. The switches are updated with the new configuration and the input shift register is disabled. With \$\overline{SYNC}\$ held high, the input shift register is disabled, so further data or noise on the DIN line will have no effect on the shift register.

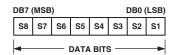


Figure 3. Input Shift Register Contents

SERIAL INTERFACE

2-Wire Serial Interface

The ADG715 is controlled via an I²C-compatible serial bus. This device is connected to the bus as a slave device (no clock is generated by the switch).

The ADG715 has a 7-bit slave address. The five MSBs are 10010 and the two LSBs are determined by the state of the A0 and A1 pins.

-12- REV. C

The 2-wire serial bus protocol operates as follows:

- The master initiates data transfer by establishing a START condition, which is when a high-to-low transition on the SDA line occurs while SCL is high. The following byte is the address byte that consists of the 7-bit slave address followed by a R\overline{W} bit (this bit determines whether data will be read from or written to the slave device).
 - The slave whose address corresponds to the transmitted address responds by pulling the SDA line low during the ninth clock pulse (this is termed the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its serial register. If the R/\overline{W} bit is high, the master will read from the slave device. However, if the R/\overline{W} bit is low, the master will write to the slave device.
- Data is transmitted over the serial bus in sequences of nine clock pulses (eight data bits followed by an acknowledge bit).
 The transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL.
- 3. When all data bits have been read or written, a STOP condition is established by the master. A STOP condition is defined as a low-to-high transition on the SDA line while SCL is high. In write mode, the master will pull the SDA line high during the tenth clock pulse to establish a STOP condition. In read mode, the master will issue a no acknowledge for the ninth clock pulse (i.e., the SDA line remains high). The master will then bring the SDA line low before the tenth clock pulse and then high during the tenth clock pulse to establish a STOP condition.

See Figure 4 for a graphical explanation of the serial interface.

A repeated write function gives the user flexibility to update the matrix switch a number of times after addressing the part only once. During the write cycle, each data byte will update the configuration of the switches. For example, after the matrix switch has acknowledged its address byte, and received one data byte, the switches will update after the data byte; if another data byte is written to the matrix switch while it is still the addressed slave device, this data byte will also cause a switch configuration update. Repeat read of the matrix switch is also allowed.

Input Shift Register

The input shift register is eight bits wide. Figure 3 illustrates the contents of the input shift register. Data is loaded into the device as an 8-bit word under the control of a serial clock input, SCL. The timing diagram for this operation is shown in Figure 2. The 8-bit word consists of eight data bits, each controlling one switch. MSB (Bit 7) is loaded first.

Write Operation

When writing to the ADG715, the user must begin with an address byte and R/\overline{W} bit, after which the switch will acknowledge that it is prepared to receive data by pulling SDA low. This address byte is followed by the 8-bit word. The write operation for the switch is shown in the Figure 4.

READ Operation

When reading data back from the ADG715, the user must begin with an address byte and R/\overline{W} bit, after which the switch will acknowledge that it is prepared to transmit data by pulling SDA low. The readback operation is a single byte that consists of the eight data bits in the input register. The read operation for the part is shown in Figure 5.

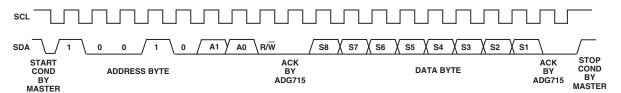


Figure 4. ADG715 Write Sequence

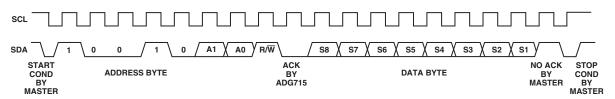


Figure 5. ADG715 Readback Sequence

REV. C –13–

APPLICATIONS

Multiple Devices On One Bus

Figure 6 shows four ADG715 devices on the same serial bus. Each has a different slave address since the state of their A0 and A1 pins is different. This allows each switch to be written to or read from independently.

Daisy-Chaining Multiple ADG714s

A number of ADG714 switches may be daisy-chained simply by using the DOUT pin. Figure 7 shows a typical implementation. The \overline{SYNC} pin of all three parts in the example are tied together. When \overline{SYNC} is brought low, the input shift registers of all parts are enabled, data is written to the parts via DIN, and clocked through the shift registers. When the transfer is complete, \overline{SYNC} is brought high and all switches are updated simultaneously. Further shift registers may be added in series.

Power Supply Sequencing

When using CMOS devices, care must be taken to ensure correct power-supply sequencing. Incorrect power-supply sequencing can result in the device being subjected to stresses beyond those maximum ratings listed in the data sheet. Digital and analog inputs should always be applied after power supplies and ground. In dual supply applications, if digital or analog inputs may be applied to the device prior to the $V_{\rm DD}$ and $V_{\rm SS}$ supplies, the addition of a Schottky diode connected between $V_{\rm SS}$ and GND will ensure that the device powers on correctly. For single supply operation, $V_{\rm SS}$ should be tied to GND as close to the device as possible.

Decoding Multiple ADG714s Using an ADG739

The dual 4-channel ADG739 multiplexer can be used to multiplex a single chip select line to provide chip selects for up to four

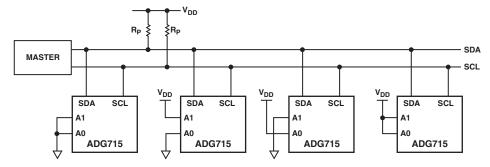


Figure 6. Multiple ADG715s On One Bus

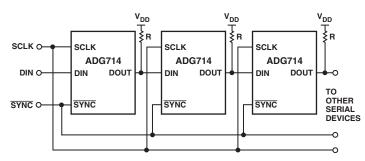


Figure 7. Multiple ADG714 Devices in a Daisy-Chained Configuration

-14-

devices on the SPI bus. Figure 8 illustrates the ADG739 and multiple ADG714s in such a typical configuration. All devices receive the same serial clock and serial data, but only one device will receive the SYNC signal at any one time. The ADG739 is a serially controlled device also. One bit programmable pin of the microcontroller is used to enable the ADG739 via SYNC2, while another bit programmable pin is used as the chip select for the other serial devices, SYNC1. Driving SYNC2 low enables changes to be made to the addressed serial devices. By bringing SYNC1 low, the selected serial device hanging from the SPI bus will be enabled and data will be clocked into its shift register on the falling edges of SCLK. The convenient design of the matrix switch allows for different combinations of the four serial devices to be addressed at any one time. If more devices need to be addressed via one chip select line, the ADG738 is an 8channel device and would allow further expansion of the chip select scheme. There may be some digital feedthrough from the digital input lines because SCLK and DIN are permanently connected to each device. Using a burst clock will minimize the effects of digital feedthrough on the analog channels.

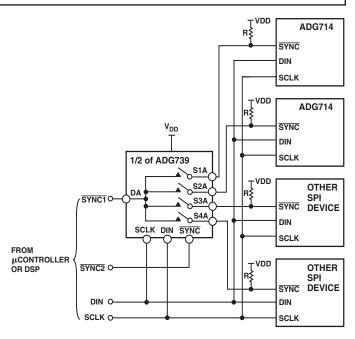
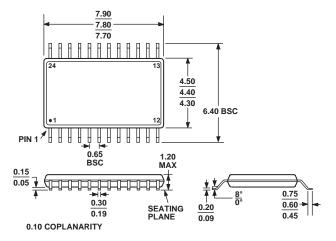


Figure 8. Addressing Multiple ADG714s Using an ADG739

REV. C –15–

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-AD

Figure 1. 24-Lead Thin Shrink Small Outline Package [TSSOP] (RU-24) Dimensions shown in millimeters

ORDERING GUIDE

| ONDENING GOIDE | | | | |
|--------------------|-------------------|---------------------|----------------|--|
| Model ¹ | Temperature Range | Package Description | Package Option | |
| ADG714BRU-REEL | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG714BRU-REEL7 | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG714BRUZ | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG714BRUZ-REEL | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG714BRUZ-REEL7 | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRU | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRU-REEL | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRU-REEL7 | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRUZ | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRUZ-REEL | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |
| ADG715BRUZ-REEL7 | -40°C to +85°C | 24-Lead TSSOP | RU-24 | |

¹ Z = RoHS Compliant Part.

REVISION HISTORY

1/13—Rev. B to Rev. C

Changes to Dual Supply Table Summary and IDD Test

 Edits to Features
 1

 Edits to General Description
 1

 Edits to Product Highlights
 1

 Edits to Specifications
 3, 4

 Edits to TPCs 2 and 5
 10

 Edits to TPCs 8 and 9
 11

 Edits to TPCs 14
 12

 Edits to Figure 8
 15

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-16- REV. C